



**DMN10H700S** 

**100V N-CHANNEL ENHANCEMENT MODE MOSFET** 

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3) Qualified to AEC-Q101 Standards for High Reliability

Case Material: Molded Plastic. UL Flammability Classification

Moisture Sensitivity: Level 1 per J-STD-020

Terminal Connections: See Diagram

Weight: 0.006 grams (Approximate)

Terminals: Solderable per MIL-STD-202, Method 208 Lead Free Plating (Matte Tin Finish Annealed over Alloy 42

Features and Benefits
Low Gate Threshold Voltage
Low Input Capacitance
Fast Switching Speed
Small Surface Mount Package

Mechanical Data

Case: SOT23

Rating 94V-0

Leadframe). (03)

## Product Summary

| BV <sub>DSS</sub> | Rds(on)                                | Ι <sub>D</sub><br>T <sub>A</sub> = +25°C |
|-------------------|--|--|
| 4001/             | $700m\Omega @ V_{GS} = 10V$            | 0.70A                                    |
| 100V              | 900m $\Omega$ @ V <sub>GS</sub> = 6.0V | 0.62A                                    |

## Description

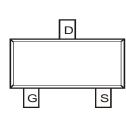
This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

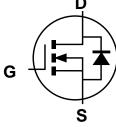


Top View



Top View

Pin Configuration



Equivalent Circuit

### Ordering Information (Note 4)

| Part Number   | Case  | Packaging          |
|---------------|-------|--------------------|
| DMN10H700S-7  | SOT23 | 3,000/Tape & Reel  |
| DMN10H700S-13 | SOT23 | 10,000/Tape & Reel |

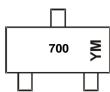
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



700 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: E= 2017) M = Month (ex: 9 = September)

#### Date Code Key

| Bate Boad He | <i></i> |      |      |      |      |      |       |       |     |      |      |      |
|--------------|---------|------|------|------|------|------|-------|-------|-----|------|------|------|
| Year         | 2015    | 2016 | 2017 | 2018 | 2019 | 2020 | ) 202 | 21 20 | 022 | 2023 | 2024 | 2025 |
| Code         | С       | D    | E    | F    | G    | Н    |       |       | J   | K    | L    | М    |
| Month        | Jan     | Feb  | Mar  | Apr  | Мау  | Jun  | Jul   | Aug   | Sep | Oct  | Nov  | Dec  |
| Code         | 1       | 2    | 3    | 4    | 5    | 6    | 7     | 8     | 9   | 0    | N    | D    |



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic  | Symbol           | Value | Unit           |              |   |
|---|------------------|-------|----------------|--------------|---|
| Drain-Source Voltage  | V <sub>DSS</sub> | 100   | V              |              |   |
| Gate-Source Voltage   | V <sub>GSS</sub> | ±20   | V              |              |   |
| Continuous Drain Current (Note 6) $V_{GS} = 10V$ Steady $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ |                  |       | ID             | 0.70<br>0.56 | A |
| Pulsed Drain Current (10µs Pulse, Duty Cycle ≦1%)   | I <sub>DM</sub>  | 2.5   | А              |              |   |
| Maximum Body Diode Continuous Current (Note 6)  |                  |       | I <sub>S</sub> | 0.6          | А |

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                   |                    | Symbol           | Value       | Unit |  |
|--|--------------------|------------------|-------------|------|--|
| Total Rower Dissinction                          | (Note 5)           | D                | 0.4         | W    |  |
| Total Power Dissipation                          | (Note 6)           | PD               | 0.5         | VV   |  |
| Thermal Resistance, Junction to Ambient (Note 5) | mbient (Note 5)    |                  | 303         |      |  |
| Thermal Resistance, Junction to Ambient (Note 6) | te 6) Steady state |                  | 239         | °C/W |  |
| Thermal Resistance, Junction to Case (Note 6)    |                    | R <sub>θJC</sub> | 88          |      |  |
| Operating and Storage Temperature Range          |                    | TJ, TSTG         | -55 to +150 | °C   |  |

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                    | Symbol                   | Min | Тур | Max  | Unit  | Test Condition   |  |
|-----------------------------------|--------------------------|-----|-----|------|-------|--|--|
| OFF CHARACTERISTICS (Note 7)      |                          |     |     | -    |       |  |  |
| Drain-Source Breakdown Voltage    | <b>BV</b> <sub>DSS</sub> | 100 |     |      | V     | $V_{GS} = 0V, I_D = 250 \mu A$                             |  |
| Zero Gate Voltage Drain Current   | I <sub>DSS</sub>         |     | —   | 1    | μA    | $V_{DS} = 100V, V_{GS} = 0V$                               |  |
| Gate-Source Leakage               | I <sub>GSS</sub>         | _   | —   | ±100 | nA    | $V_{GS} = \pm 20V, V_{DS} = 0V$                            |  |
| ON CHARACTERISTICS (Note 7)       |                          |     |     |      |       |  |  |
| Gate Threshold Voltage            | V <sub>GS(TH)</sub>      | 2.0 | 2.7 | 4.0  | V     | $V_{DS} = V_{GS}, I_D = 250 \mu A$                         |  |
| Static Drain-Source On-Resistance | Р                        | _   | 540 | 700  | mΩ    | $V_{GS} = 10V, I_D = 1.5A$                                 |  |
|                                   | R <sub>DS(ON)</sub>      |     | 550 | 900  | 11122 | $V_{GS} = 6.0V, I_D = 1.0A$                                |  |
| Diode Forward Voltage             | V <sub>SD</sub>          |     | 0.9 | 1.1  | V     | $V_{GS} = 0V, I_S = 1.5A$                                  |  |
| DYNAMIC CHARACTERISTICS (Note 8)  |                          |     |     |      |       |  |  |
| Input Capacitance                 | Ciss                     | _   | 235 |      |       | $V_{DS} = 50V, V_{GS} = 0V,$<br>f = 1.0MHz                 |  |
| Output Capacitance                | C <sub>oss</sub>         | _   | 7   |      | pF    |  |  |
| Reverse Transfer Capacitance      | Crss                     | _   | 5   | _    |       |  |  |
| Gate Resistance                   | R <sub>G</sub>           |     | 1.9 | _    | Ω     | $V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$                     |  |
| Total Gate Charge                 | Qq                       |     | 4.6 | —    |       |  |  |
| Gate-Source Charge                | Q <sub>gs</sub>          |     | 1.1 | _    | nC    | $V_{DS} = 50V, V_{GS} = 10V,$                              |  |
| Gate-Drain Charge                 | Q <sub>qd</sub>          | _   | 1.6 |      | 1     | I <sub>D</sub> = 1.0A                                      |  |
| Turn-On Delay Time                | t <sub>D(ON)</sub>       |     | 2.5 | —    |       |  |  |
| Turn-On Rise Time                 | t <sub>R</sub>           |     | 1.1 | _    |       | $V_{DS} = 50V, I_D = 1.0A,$                                |  |
| Turn-Off Delay Time               | t <sub>D(OFF)</sub>      |     | 5.4 | _    | ns    | $V_{GS} = 10V, R_{G} = 6.0\Omega$                          |  |
| Turn-Off Fall Time                | tF                       |     | 1.0 | _    | 1     |  |  |
| Reverse Recovery Time             | t <sub>RR</sub>          | _   | 22  |      | ns    |  |  |
| Reverse Recovery Charge           | Q <sub>RR</sub>          |     | 15  |      | nC    | V <sub>R</sub> = 100V, I <sub>F</sub> =1.8A, di/dt=100A/µs |  |

Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

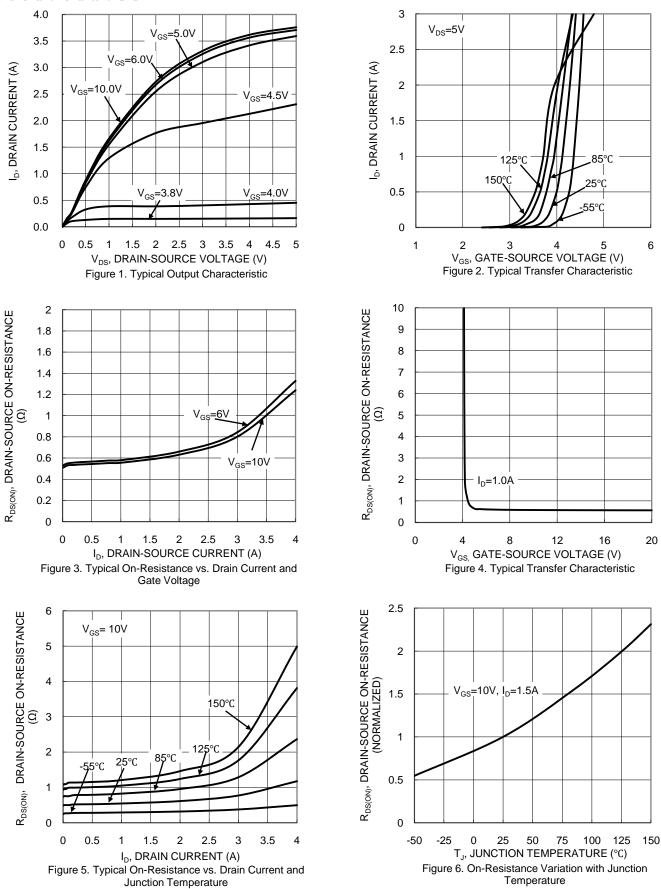
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.

7 .Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to production testing.

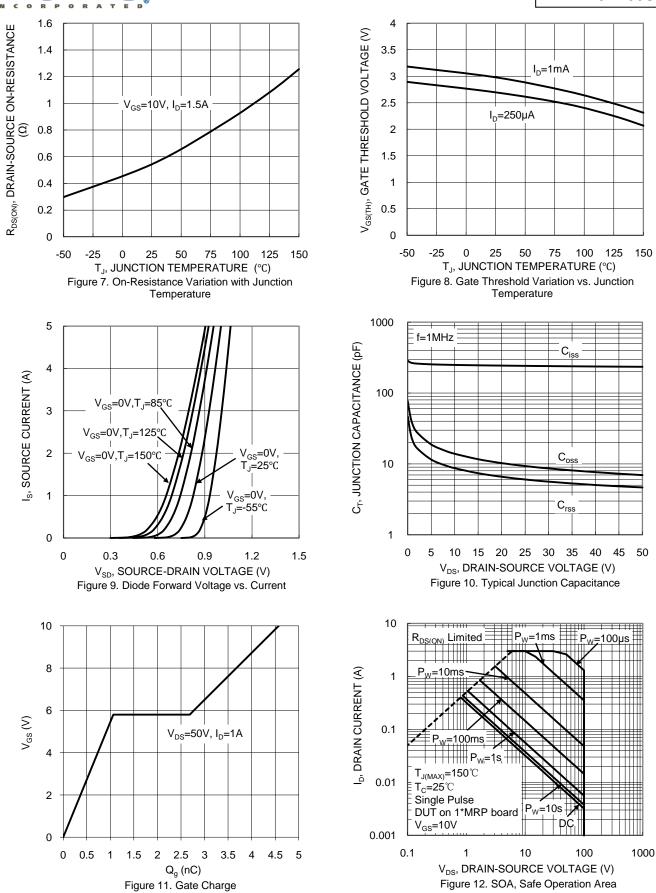


## **DMN10H700S**

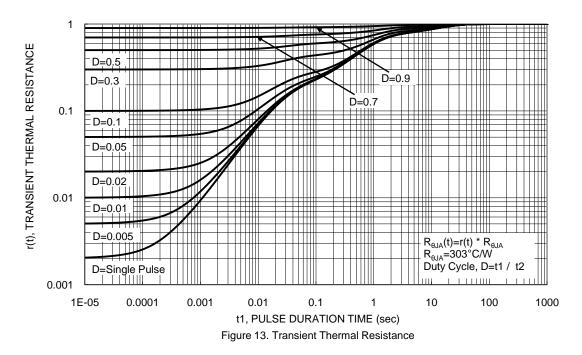










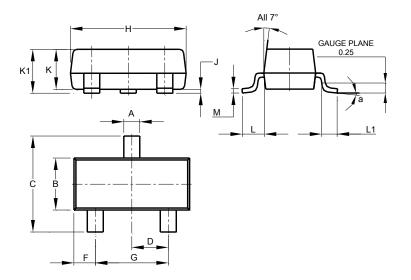




# Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

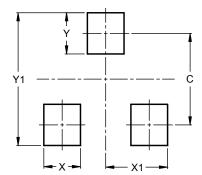


| SOT23                |       |       |       |  |  |  |  |  |
|----------------------|-------|-------|-------|--|--|--|--|--|
| Dim                  | Min   | Max   | Тур   |  |  |  |  |  |
| Α                    | 0.37  | 0.51  | 0.40  |  |  |  |  |  |
| В                    | 1.20  | 1.40  | 1.30  |  |  |  |  |  |
| С                    | 2.30  | 2.50  | 2.40  |  |  |  |  |  |
| D                    | 0.89  | 1.03  | 0.915 |  |  |  |  |  |
| F                    | 0.45  | 0.60  | 0.535 |  |  |  |  |  |
| G                    | 1.78  | 2.05  | 1.83  |  |  |  |  |  |
| Н                    | 2.80  | 3.00  | 2.90  |  |  |  |  |  |
| J                    | 0.013 | 0.10  | 0.05  |  |  |  |  |  |
| K                    | 0.890 | 1.00  | 0.975 |  |  |  |  |  |
| K1                   | 0.903 | 1.10  | 1.025 |  |  |  |  |  |
| L                    | 0.45  | 0.61  | 0.55  |  |  |  |  |  |
| L1                   | 0.25  | 0.55  | 0.40  |  |  |  |  |  |
| М                    | 0.085 | 0.150 | 0.110 |  |  |  |  |  |
| а                    | 0°    | 8°    |       |  |  |  |  |  |
| All Dimensions in mm |       |       |       |  |  |  |  |  |

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



| Dimensions | Value (in mm) |  |  |  |  |  |
|------------|---------------|--|--|--|--|--|
| С          | 2.0           |  |  |  |  |  |
| Х          | 0.8           |  |  |  |  |  |
| X1         | 1.35          |  |  |  |  |  |
| Y          | 0.9           |  |  |  |  |  |
| Y1         | 2.9           |  |  |  |  |  |



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